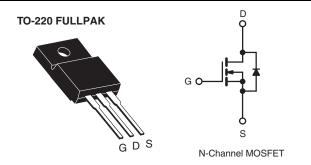


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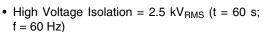
## **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	900			
$R_{DS(on)}\left(\Omega\right)$	V <sub>GS</sub> = 10 V	3.7		
Q <sub>g</sub> (Max.) (nC)	78			
Q <sub>gs</sub> (nC)	10			
Q <sub>gd</sub> (nC)	42			
Configuration	Single			



#### **FEATURES**

· Isolated Package





• Sink to Lead Creepage Distance = 4.8 mm

- · Dynamic dV/dt Rating
- · Low Thermal Resistance
- · Lead (Pb)-free Available

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION		
Package	TO-220 FULLPAK	
Lead (Pb)-free	IRFIBF30GPbF	
Lead (PD)-liee	SiHFIBF30G-E3	
SnPb	IRFIBF30G	
SILL	SiHFIBF30G	

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V <sub>DS</sub>	900	V	
Gate-Source Voltage	$V_{GS}$	± 20			
Continuous Drain Current	$V_{GS}$ at 10 V $T_C = 25 ^{\circ}C$	,	1.9	A	
	T <sub>C</sub> =100°C	I <sub>D</sub>	1.2		
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	7.6	1		
Linear Derating Factor			0.28	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	220	mJ		
Repetitive Avalanche Currenta	I <sub>AR</sub>	1.9	Α		
Repetitive Avalanche Energy <sup>a</sup>	E <sub>AR</sub>	3.5	mJ		
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	$P_{D}$	35	W	
Peak Diode Recovery dV/dtc	dV/dt	1.5	V/ns		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s		300 <sup>d</sup>	7	
Mounting Torque	6-32 or M3 screw		10	lbf ⋅ in	
	0-32 OF IVIS SCIEW		1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 115 mH,  $R_G$  = 25  $\Omega$ ,  $I_{AS}$  = 1.9 A (see fig. 12). c.  $I_{SD} \le 3.6$  A,  $dI/dt \le 70$  A/ $\mu$ s,  $V_{DD} \le 600$ ,  $T_J \le 150$  °C.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFIBF30G, SiHFIBF30G

# Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	65	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	3.6	C/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		•					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		900	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	1.1	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
7 0 1 1/1 1 2 1 0 1		V <sub>DS</sub> =	V <sub>DS</sub> = 900 V, V <sub>GS</sub> = 0 V		-	100	,
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 720 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	500	μΑ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 1.1 A <sup>b</sup>	-	-	3.7	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 1.1 A <sup>b</sup>		-	-	S
Dynamic					•		
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V$ ,		-	1200	-	
Output Capacitance	C <sub>oss</sub>	1	$V_{DS} = 25 \text{ V},$		320	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	200	-	pF
Drain to Sink Capacitance	С		f = 1.0 MHz	-	12	-	
Total Gate Charge	Qg		I <sub>D</sub> = 3.6 A, V <sub>DS</sub> = 360 V, see fig. 6 and 13 <sup>b</sup>	-	-	78	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	-	10	
Gate-Drain Charge	Q <sub>gd</sub>	1		-	-	42	
Turn-On Delay Time	t <sub>d(on)</sub>				14	-	- ns
Rise Time	t <sub>r</sub>	$V_{DD} = 450 \text{ V}, I_D = 3.6 \text{ A},$ $R_G = 12 \Omega, R_D = 120 \Omega,$ see fig. $10^b$		-	25	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	90	-	
Fall Time	t <sub>f</sub>			-	30	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s	•				•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	1.9	- A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			_	-	7.6	
Body Diode Voltage	$V_{SD}$	$T_J = 25 ^{\circ}\text{C},  I_S = 1.9  \text{A},  V_{GS} = 0  \text{V}^{\text{b}}$		-	-	1.8	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 3.6 A, dl/dt = 100 A/μs <sup>b</sup>		-	430	650	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	1.4	2.1	μС
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				L <sub>D</sub> )	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

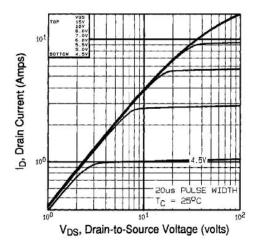


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

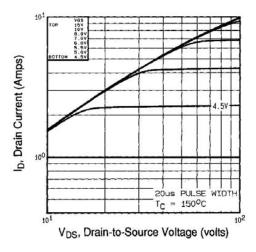


Fig. 2 - Typical Output Characteristics,  $T_C$  = 150 °C

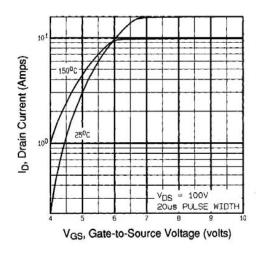


Fig. 3 - Typical Transfer Characteristics

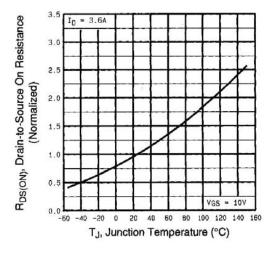


Fig. 4 - Normalized On-Resistance vs. Temperature

## IRFIBF30G, SiHFIBF30G

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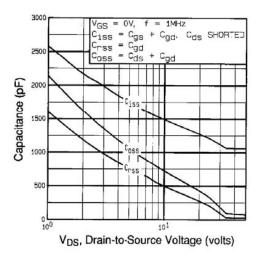


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

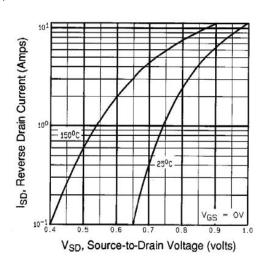


Fig. 7 - Typical Source-Drain Diode Forward Voltage

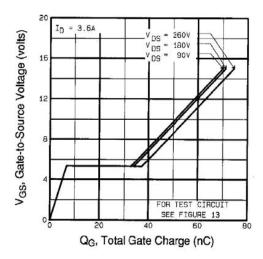


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

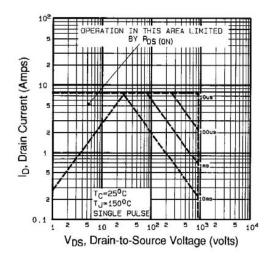


Fig. 8 - Maximum Safe Operating Area



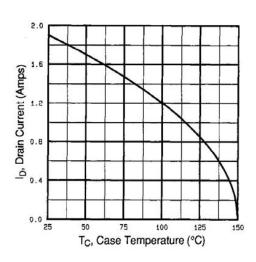


Fig. 9 - Maximum Drain Current vs. Case Temperature

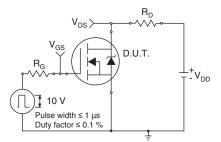


Fig. 10a - Switching Time Test Circuit

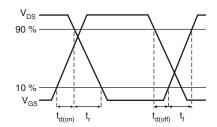


Fig. 10b - Switching Time Waveforms

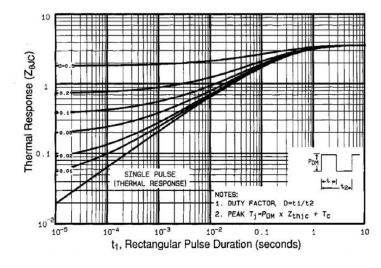


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

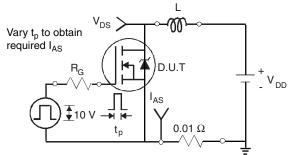


Fig. 12a - Unclamped Inductive Test Circuit

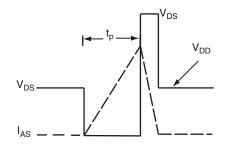


Fig. 12b - Unclamped Inductive Waveforms

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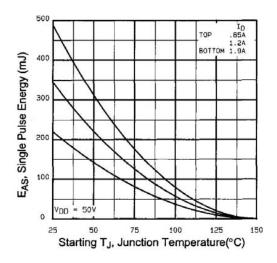


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

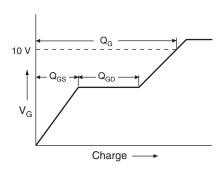


Fig. 13a - Basic Gate Charge Waveform

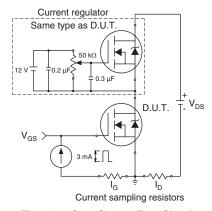
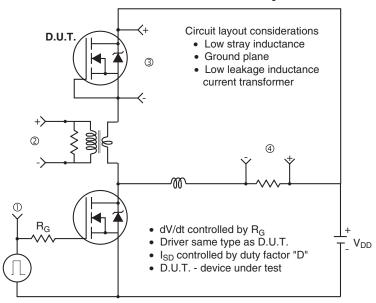
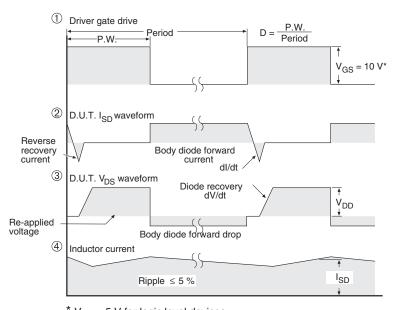


Fig. 13b - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit





 $^*$  V<sub>GS</sub> = 5 V for logic level devices

Fig.14 - For N-Channel

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